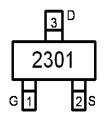


Main Product Characteristics:

V _{DSS}	-20V	
R _{DS} (on)	60mΩ (typ.)	
I _D	-3A 1	

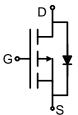


SOT-23



Marking and pin

Assignment



Schematic diagram

Features and Benefits:

- Advanced MOSFET process technology
- Special designed for PWM, load switching and general purpose applications
- Ultra low on-resistance with low gate charge
- Fast switching and reverse body recovery
- 150°C operating temperature



Description:

It utilizes the latest processing techniques to achieve the high cell density and reduces the on-resistance with high repetitive avalanche rating. These features combine to make this design an extremely efficient and reliable device for use in power switching application and a wide variety of other applications.

Absolute max Rating: @T_A=25°C unless otherwise specified

Symbol	Parameter	Max.	Units
I _D @ TC = 25°C	Continuous Drain Current, V _{GS} @ 10V	-3 ①	
I _D @ TC = 70°C	Continuous Drain Current, V _{GS} @ 10V	-1.8 ①	А
I _{DM}	Pulsed Drain Current 2	-10	
P _D @TC = 25°C	Power Dissipation 3	1.25	W
V _{DS}	Drain-Source Voltage	-20	V
V _{GS}	Gate-to-Source Voltage	± 12	V
T _J T _{STG}	Operating Junction and Storage Temperature Range	-55 to +150	°C

Thermal Resistance

Symbol	Characterizes	Тур.	Max.	Units
R _{0JA}	Junction-to-ambient (t \leq 10s) ④		100	°C /W



Symbol	Parameter	Min.	Тур.	Max.	Units	Conditions
V _{(BR)DSS}	Drain-to-Source breakdown voltage	-20	_	_	V	$V_{GS} = 0V, I_D = -250 \mu A$
D	Static Drain-to-Source on-resistance	_	60	90		V _{GS} =-4.5V,I _D = -3A
$R_{DS(on)}$	Static Dram-to-Source on-resistance	_	85	115	mΩ	V _{GS} =-2.5V,I _D = -2A
M	Cate threshold voltage	-0.5	—	-1	V	$V_{DS} = V_{GS}, I_D = -250 \mu A$
V _{GS(th)}	Gate threshold voltage	_	-0.58	_	v	T _J = 125°C
I _{DSS}	Drain to Source lookage ourrent	_	—	-1		$V_{DS} = -20V, V_{GS} = 0V$
IDSS	Drain-to-Source leakage current	_	—	-50	μA	T _J = 125°C
	Cata to Source forward lookage	_	_	100	nA	V _{GS} =12V
I _{GSS} Gat	Gate-to-Source forward leakage	_	—	-100		V _{GS} = -12V
Qg	Total gate charge	_	9.6	_		I _D = -3A,
Q_{gs}	Gate-to-Source charge	_	1.1	_	nC	V _{DS} =-10V,
Q_{gd}	Gate-to-Drain("Miller") charge	_	2.6	_		$V_{GS} = -4.5V$
t _{d(on)}	Turn-on delay time	_	9.7	_		
tr	Rise time	_	18	_		V_{GS} =-4.5V, V_{DS} =-20V,
$t_{d(off)}$	Turn-Off delay time	_	25	_	ns	R _{GEN} =3Ω
t _f	Fall time		31	_		
C _{iss}	Input capacitance	_	490	_		$V_{GS} = 0V,$
C _{oss}	Output capacitance	—	75	—	pF	V _{DS} =-10V,
C _{rss}	Reverse transfer capacitance	—	60	—		f = 1MHz

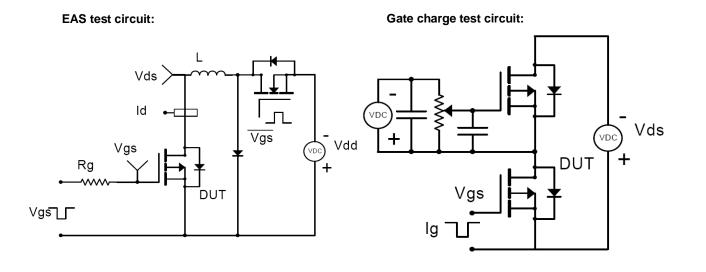
Electrical Characterizes $@T_A=25^{\circ}C$ unless otherwise specified

Source-Drain Ratings and Characteristics

Symbol	Parameter	Min.	Тур.	Max.	Units	Conditions
I _S	Continuous Source Current		—	-3 ①	A	MOSFET symbol
	(Body Diode)	_				showing the
I _{SM}	Pulsed Source Current		—	-10	A	integral reverse
	(Body Diode)	_				p-n junction diode.
V _{SD}	Diode Forward Voltage	_	-0.83	-1.2	V	I _S =-0.75A, V _{GS} =0V

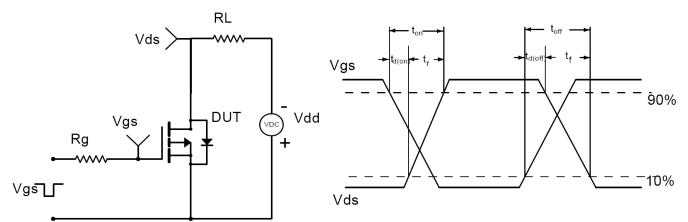


Test circuits and Waveforms



Switching time test circuit:

Switch Waveforms:

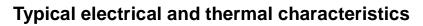


Notes:

- ①Calculated continuous current based on maximum allowable junction temperature.
- 2 Repetitive rating; pulse width limited by max. junction temperature.
- ③The power dissipation PD is based on max. junction temperature, using junction-to-case thermal resistance.
- (4) The value of $R_{\theta JA}$ is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with TA =25°C



SSF2301



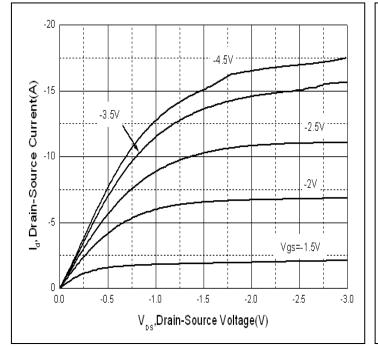


Figure 1: Typical Output Characteristics

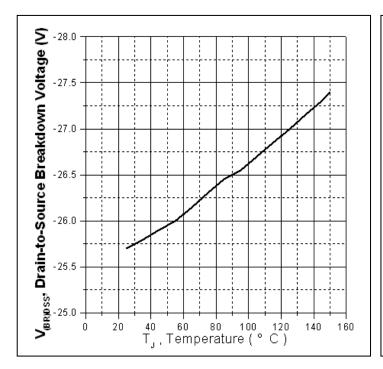


Figure 3. Drain-to-Source Breakdown Voltage Vs. Case Temperature

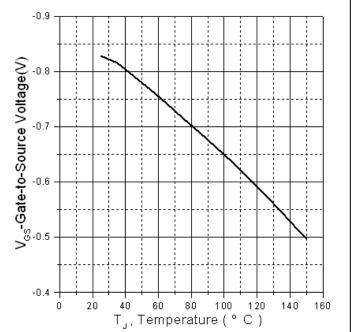
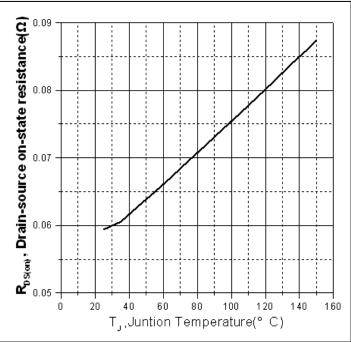


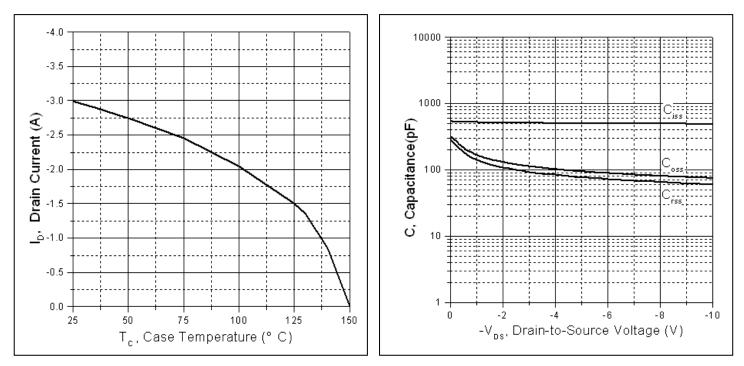
Figure 2. Gate to source cut-off voltage







SSF2301



Typical electrical and thermal characteristics



Figure 6. Typical Capacitance Vs. Drain-to-Source Voltage

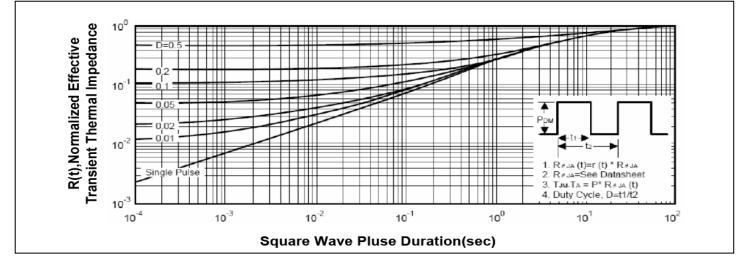
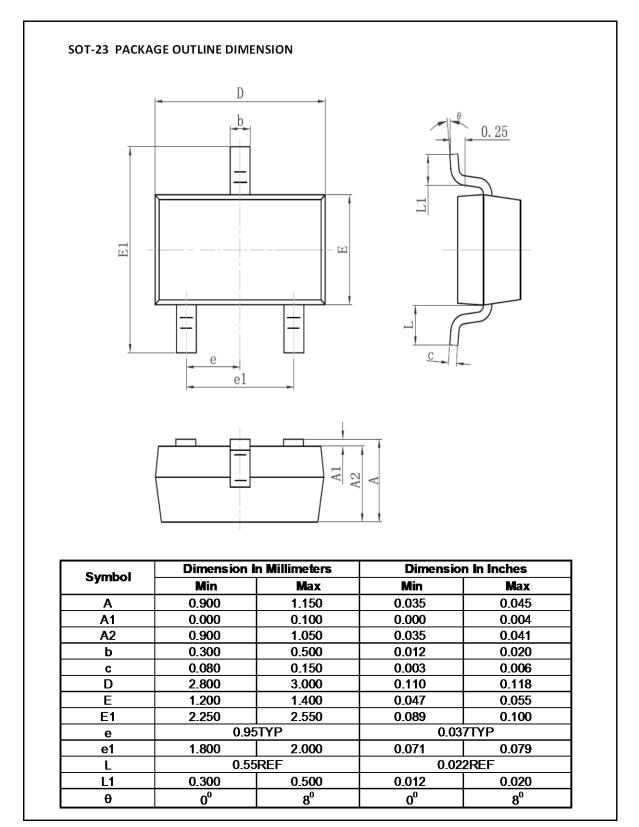


Figure7. Maximum Effective Transient Thermal Impedance Junction-to-Case



Mechanical Data:





Ordering and Marking Information

Device Marking: 2301		
	Package (Available)	
	SOT23	
	Operating Temperature Range	
	C : -55 to 150 °C	

Devices per Unit

Package Type		Tapes/Inner Box	Units/Inner Box	Inner Boxes/Carton Box	Units/Carton Box
SOT23	3000	10	30000	4	120000

Reliability Test Program

Test Item	Conditions	Duration	Sample Size
High	Tj=125℃ to 150℃ @	168 hours	3 lots x 77 devices
Temperature	80% of Max	500 hours	
Reverse	V _{DSS} /V _{CES} /V _R	1000 hours	
Bias(HTRB)			
High	Tj=150℃ @ 100% of	168 hours	3 lots x 77 devices
Temperature	Max V _{GSS}	500 hours	
Gate		1000 hours	
Bias(HTGB)			



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